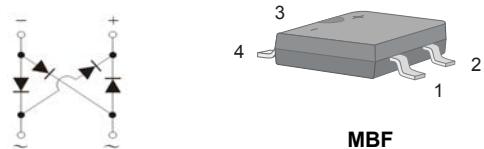


Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Ideal for printed circuit board
- Glass passivated junction chip
- Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed 250°C/10 seconds at terminals



Schematic Diagram

PIN	DESCRIPTION
1	Input Pin (~)
2	Input Pin (~)
3	Output Anode (+)
4	Output Cathode (-)

Mechanical Data

- Case: Molded plastic body
- Terminals: Plated leads solderable per MIL-STD-750, Method 2026
- Polarity : Polarity symbol marking on body
- Mounting position: Any
- Weight: 0.0027oz., 0.078g



Maximum Ratings and Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	GSB2F	GSB4F	GSB6F	GSB8F	GSB10F	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at $T_L=100^\circ\text{C}$ On Glass-Epoxy P.C.B. ¹	$I_{F(AV)}$	0.8					A
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed On Rated Load	I_{FSM}	30					A
Rating For Fusing ($t=8.3\text{ms}$, $T_A=25^\circ\text{C}$)	I^2t	3.74					A^2Sec
Maximum Instantaneous Forward Voltage at 0.8A	V_F	1.1					V
Maximum DC Reverse Current at Rated DC Blocking Voltage ($T_A=25^\circ\text{C}$)	I_R	5					μA
Maximum DC Reverse Current At Rated DC Blocking Voltage ($T_A=125^\circ\text{C}$)		500					μA
Typical Junction Capacitance ²	C_J	15					pF
Typical Thermal Resistance	$R_{\theta JA}$	76					$^\circ\text{C/W}$
Operating Junction Temperature	T_J	-55 To +150					$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 To +150					$^\circ\text{C}$

Note:1.Mounted on glass epoxy PC board with 1.3*1.3mm solder pad

2.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

Ratings and Characteristics Curves

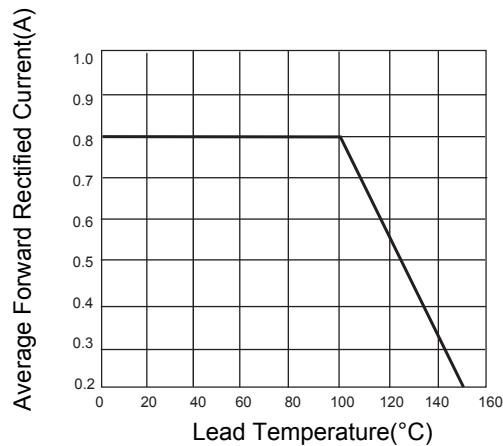


Figure 1. Derating Curve For Output Rectified Current

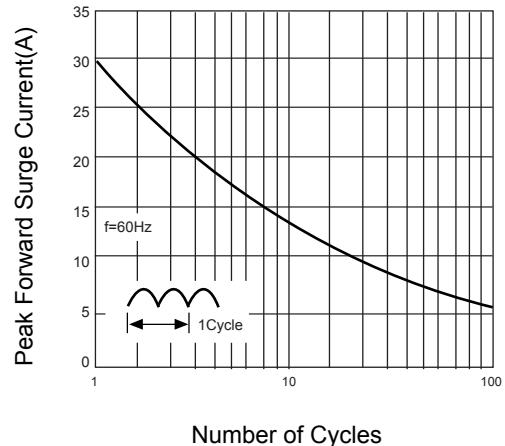


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current Per Leg

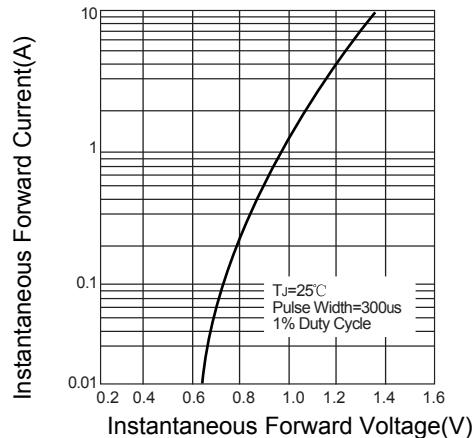


Figure 3. Typical Forward Voltage Characteristics

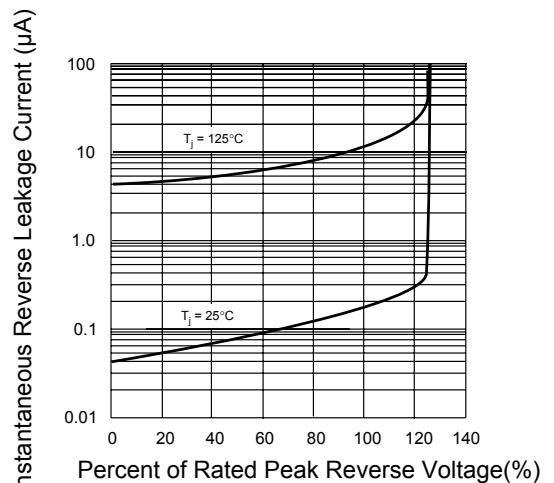
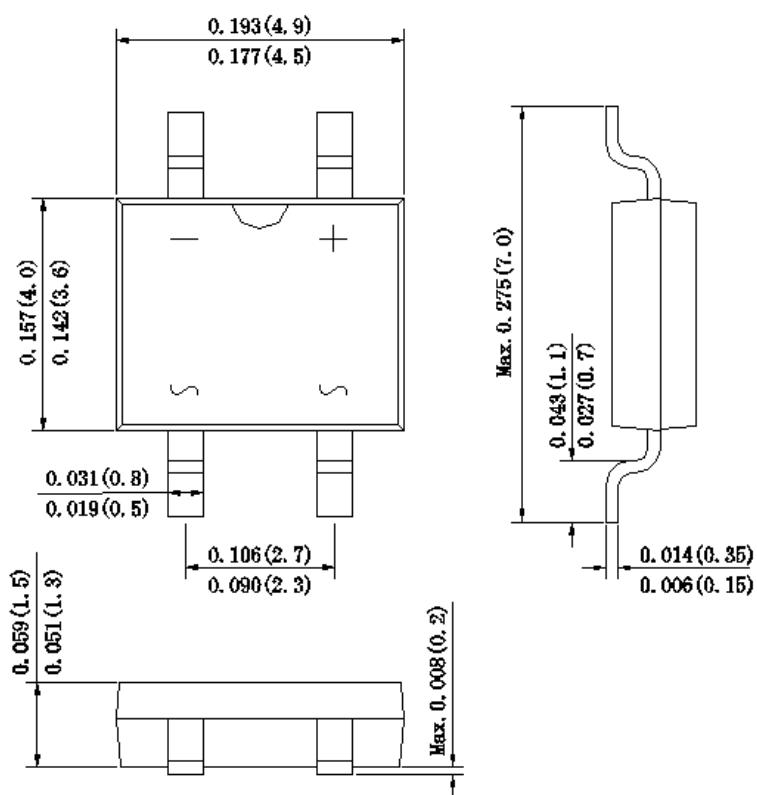


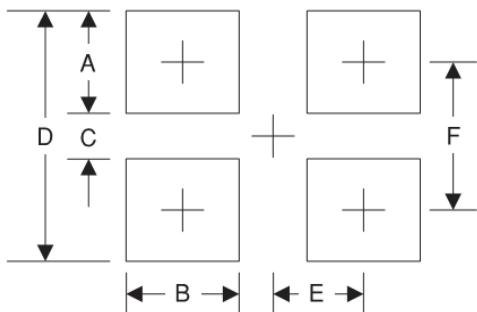
Figure 4. Typical Reverse Leakage Characteristics

Package Outline Dimensions (MBF)

Dimensions in inches and (millimeters)



Recommended Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.7	0.067
B	1.0	0.039
C	4.40	0.173
D	8.10	0.319
E	1.25	0.049
F	6.30	0.248